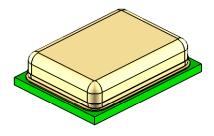


$^{\text{\tiny{TM}}}$ '4 x 3 x 1" Digital Zero-Height SiSonic $^{^{\text{\tiny{TM}}}}$ Microphone Specification





Knowles Acoustics 1151 Maplewood Drive Itasca, IL 60143





1. DESCRIPTION AND APPLICATION

1.1 DESCRIPTION Digital Surface Mount Silicon Microphone

1.2 APPLICATION Consumer electronics

2. PART MARKING

Identification Number Convention

S 1 2 3

4 5 6 7

S: Identification Marking

"S" - Knowles SiSonic Production

"E" - Knowles Engineering Samples

Digits 1-7: Job Identification Number

3. MATERIALS STATEMENT

- 3.1 Meets the requirements of the European RoHS directive, 2002/95/EC as amended.
- 3.2 Meets the requirements of the industry-standard IEC 61249-2-21:2003 for halogenated substances and Knowles Green Materials Standards Policy section on Halogen-Free.
- 3.3 Ozone depleting substances are not used in the product or the processes used to make the product, including compounds listed in annex A, B, and C of the "Montreal Protocol on Substances that deplete the Ozone Layer."

4. TEMPERATURE RANGE

- 4.1 Operating Temperature Range: -40°C to +100°C
- 4.2 Storage Temperature Range: -40°C to +100°C



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5. ABSOLUTE MAXIMUM RATINGS

Parameter	Absolute Maximum Rating	Unit
CLOCK to Ground	-0.3, +5.0	V
SELECT, V _{DD} , DATA to Ground	-0.3, +5.0	V
Input Current	±5	mA
DATA Output Short Circuit	Indefinite to Ground or V _{DD}	

Stresses at these Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. The device may not function when operated at these or any other conditions beyond those indicated under "Acoustic & Electrical Specifications". Exposure beyond those indicated under "Acoustic & Electrical Specifications" for extended periods may affect device reliability.

6. ACOUSTIC & ELECTRICAL SPECIFICATIONS

TEST CONDITIONS: 23 ± 2 °C, 60-70% R.H., V_{DD} = 1.8v, f_{clock} =2.4MHz, no load, unless otherwise specified

Parameter	Symbol	Condition		Limits		Unit
raidillelei	Syrribor	Condition	Min.	Nom.	Мах.	OTIII
Supply Voltage ¹	V _{DD}		1.6		3.6	٧
Current Consumption 1,5,6	I _{DD}			500	700	μΑ
Sleep Current ⁶	I _{SLEEP}	$f_{clock} < 1kHz$		4	7	μΑ
Directivity				Omni-di	rectional	
Sensitivity ¹	S	94 dB SPL @ 1kHz	-29	-26	-23	dBFS
Signal to Noise Ratio	SNR	94 dB SPL @ 1kHz, A-weighted		60.5		dB(A)
Total Harmonic Distortion	THD	94 dB SPL @ 1kHz			1	%
	IIID	115 dB SPL @ 1kHz			10	%
Polarity		Increasing sound pressure	Inc	reasing (density of	1's
Fall-asleep Time ^{2,3}		f _{clock} < 1kHz			10	ms
Wake-up Time ^{2,4}		f _{clock} ≥ 1MHz			20	ms
Short Circuit Output Current	Isc	Grounded output pin	2		10	mA
Output Load	Cload				160	рF
Data Format			1/2 Cycle PDM			
Clock Frequency	f _{clock}		1.0		3.25	MHz
Clock Duty Cycle			40		60	%
Clock Rise/Fall Time	tedge				13	nsec
Logic Input Low	V _{IL}		-0.3		0.35xV _{DD}	V
Logic Input High	V _{IH}		0.65xV _{DD}		3.6	>
Logic Output Low	Vol	I _{OUT} = 2ma	0		0.3xV _{DD}	V
Logic Output High	Vон	I _{0∪ T} = 2ma	0.7xV _{DD}		V _{DD}	٧
Data Time	t _{setup} + t _{edge}	160 pF Load	47			nsec
Delay time for valid data	t _{valid}	min t _{valid} valid for no load max t _{valid} valid for max Cload	18		115	nsec
Delay time for High Z	† _{hold}		0		16	nsec

^{100%} tested

 $^{^{6}}$ Specified max. values are measured at $V_{\tiny DD}$ = 3.6V



Revision: B Release Level: ACTIVE Sheet 3 of 12

² Valid microphone states are: Powered Down mode (mic off), Sleep mode (low current, no output, fast startup), and Active mode (normal operation).

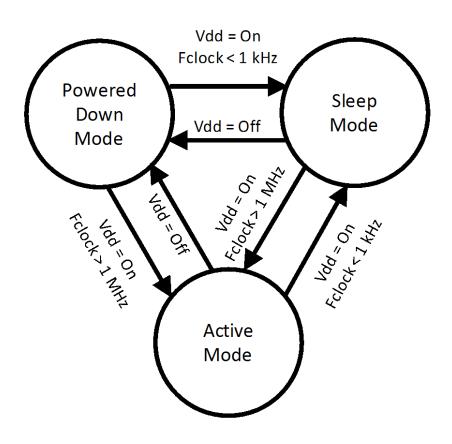
 $^{^3}$ Time from Fclock < 1 kHz to Sleep Current specification is met when transitioning from Active to Sleep mode.

 $^{^4}$ Time from Fclock \geq 1 MHz to all applicable specifications are met when transitioning from Sleep to Active mode.

 $^{^{5}}$ $\Delta I_{DD} = 0.5 * V_{DD} * C_{LOAD} * F_{CLOCK}$



7. MICROPHONE STATE DIAGRAM

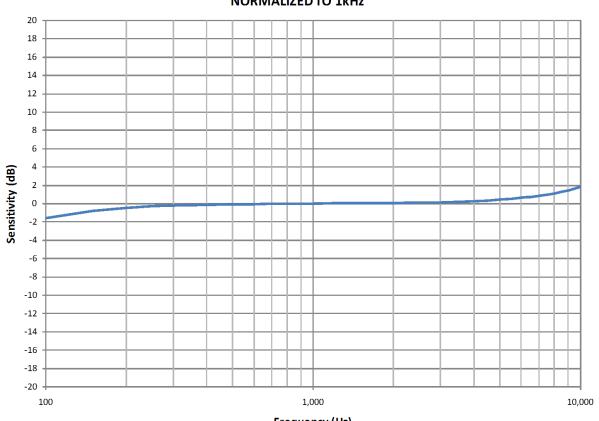






8. FREQUENCY RESPONSE CURVE

TYPICAL FREE FIELD RESPONSE NORMALIZED TO 1kHz







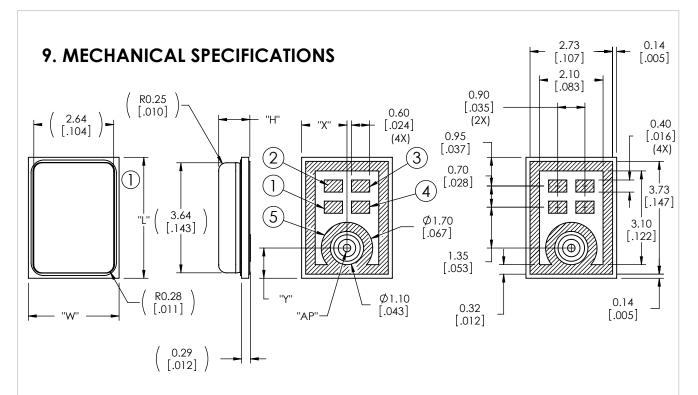
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Release Level: ACTIVE

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ITEM	DIMENSION	TOLERANCE	UNITS
LENGTH (L)	4.00	±0.100	mm
WIDTH (W)	3.00	±0.100	mm
HEIGHT (H)	1.00	±0.100	mm
ACOUSTIC PORT (AP)	Ø0.25	±0.050	mm
AP LOCATION (X)	1.50	±0.200	mm
AP LOCATION (Y)	1.00	±0.200	mm

PIN OUTPUT		
PIN #	FUNCTION	
1	POWER (VDD)	
2	OUTPUT (DATA)	
3	CLOCK (CLK)	
4	SELECT	
5	GROUND (GND)	

Note:



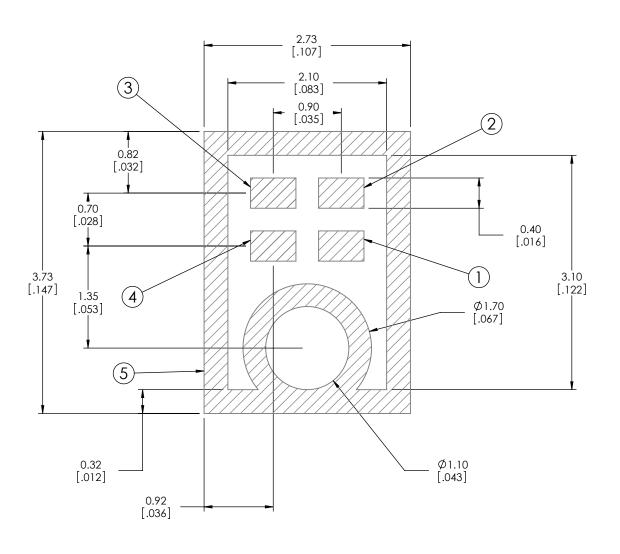
Dimensions are in milimeters unless otherwise specified.

Tolerance $\pm 0.15 mm$ unless otherwise specified.





10. RECOMMENDED CUSTOMER LAND PATTERN

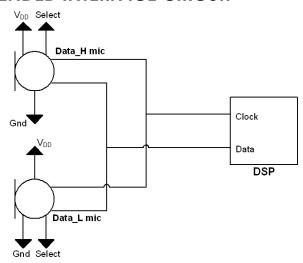


Note: Contact Knowles for Solder Stencil Information



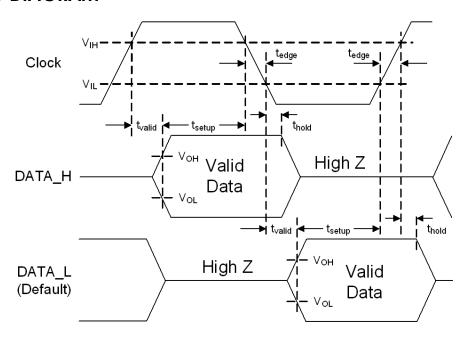


11. RECOMMENDED INTERFACE CIRCUIT



LABEL	Select	Drives data after	High-Z after
Data_H	High	Rising clock edge	Falling clock edge
Data_L	Low (Default)	Falling clock edge	Rising clock edge

12.TIMING DIAGRAM

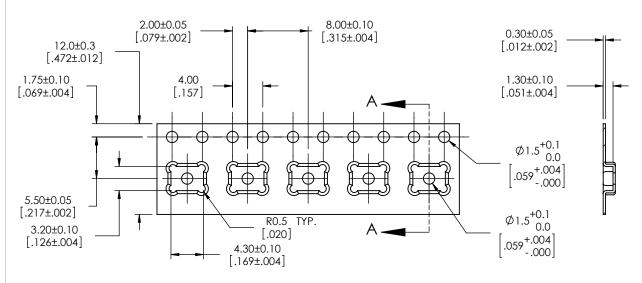


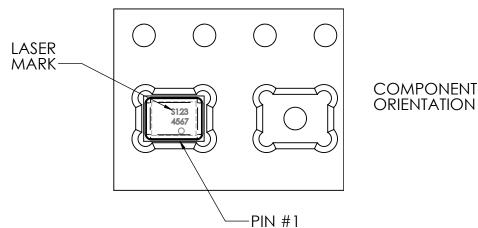
$$T_{clock}/2 = T_{edge} + T_{valid} + T_{setup}$$





13. PACKAGING DETAIL





MODEL NUMBER	SUFFIX	REEL DIAMETER	QUANTITY PER REEL
SPK0833LM4H-B	-7	13"	5,700

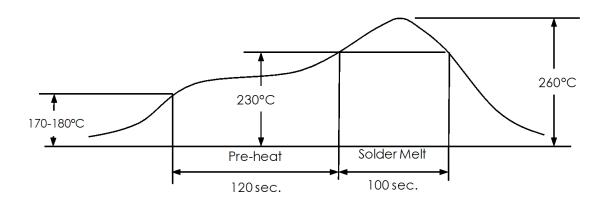
TAPE & REEL	PER EIA-481
II ABFI	LABEL APPLIED TO EXTERNAL PACKAGE & DIRECT TO REEL.

Note:

Dimensions are in milimeters unless otherwise specified.



14. SOLDER REFLOW PROFILE



Stage	Temperature Profile	Time (maximum)
Pre-heat	170 ~ 180°C	120 sec.
Solder Melt	Above 230°C	100 sec.
Peak	260°C maximum	30 sec.

15. ADDITIONAL NOTES

- Shelf life: Twelve (12) months when devices are to be stored in factory supplied, (A) unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.
- MSL (moisture sensitivity level) Class 2a.
- Do not pull a vacuum over port hole of the microphone. Pulling a vacum over the port hole can damage the device.
- (D) Do not board wash after the reflow process. Board washing and cleaning agents can damage the device. Do not expose to ultrasonic processing or cleaning.
- Do not brush board after the reflow process. Brushing the board with/without (E)
- solvents can damage the device.

 Do not insert any object in port hole of device at any time as this can damage (F) the device.
- Number of reflow Recommend no more than 3 cycles.
- Do not apply air pressure into the port hole. Air pressure over 30 psi can damage the device.





16. RELIABILITY SPECIFICATIONS

Note: After test conditions are performed, the sensitivity of the microphones shall not deviate more than 3dB from its initial value.

Test	Description
Thermal Shock	100 cycles of air-air thermal shock from -40°C to +125°C with 15 minute soaks. (IEC 68-2-4)
High Temperature Storage	+105°C environment for 1,000 hours. (IEC 68-2-2 Test Ba)
Low Temperature Storage	-40°C environment for 1,000 hours. (IEC 68-2-2 Test Aa)
High Temperature Bias	+105°C environment while under bias for 1,000 hours. (IEC 68-2-2 Test Ba)
Low Temperature Bias	-40°C environment while under bias for 1,000 hours. (IEC 68-2-2 Test Aa)
Temperature / Humidity	+85°C/85% R.H. environment while under bias for 1,000
Bias	hours. (JESD22-A101A-B)
Vibration	4 cycles lasting 12 minutes from 20 TO 2,000 Hz in X, Y and Z direction with peak acceleration of 20g. (MIL 883E, Method 2007.2, A)
Electrostatic Discharge	3 discharges at +/-8kV direct contact to lid when unit is grounded (IEC 61000-4-2) and 3 discharges at +/-2kV direct contact to I/O pins. (MIL 883E, Method 3015.7)
Reflow	5 reflow cycles with peak temperature of +260°C.
Mechanical Shock	3 pulses of 10,000g in the X, Y and Z direction. (IEC 68-2-27, Test Ea) $$





17. SPECIFICATION REVISIONS

Revision	Detailed Specification Changes	Date
Α	INITIAL RELEASE (C10113576)	04-02-12
В	SHEET 3: CHANGED DATA TIME PARAMETER FROM Tsetup TO Tsetup + Tedge. (C10113800)	06-05-12

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